

Company Presentation

Infineon Technologies AG May 2021



Infineon is a globally leading semiconductor player





top 10

semiconductor company

~46,700 employees*

leading player

in automotive, systems for power management and drives, sensor systems, connected secure systems, wireless combos, differentiated memories

9%+ I 19% I 13% target operating model**

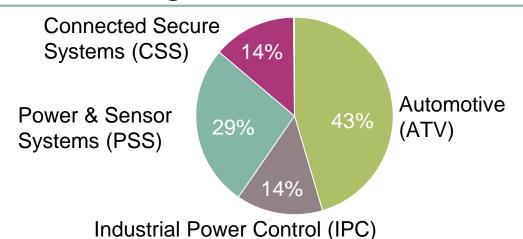
^{*} as of 30 September 2020

^{**} over the cycle 9%+ revenue growth; 19% Segment Result margin; investment-to-sales ratio of 13%; targets to be approached as integration progresses

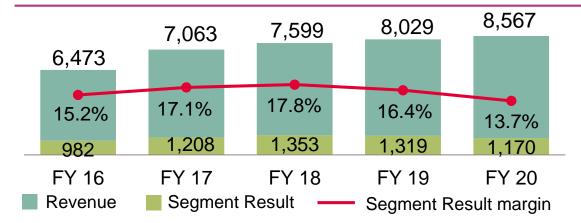
Infineon at a glance



Business Segments Revenue*



Financials



^{*2020} Fiscal Year (as of 30 September 2020)

Employees*

46,700 employees worldwide

Americas 5,200

60 R&D locations19 manufacturing locations**

Market Position

Automotive



1
Strategy Analytics,
April 2021

Power



1
Omdia,
September 2020

EMEA 19,100

Asia/Pacific 22,400

Microcontroller



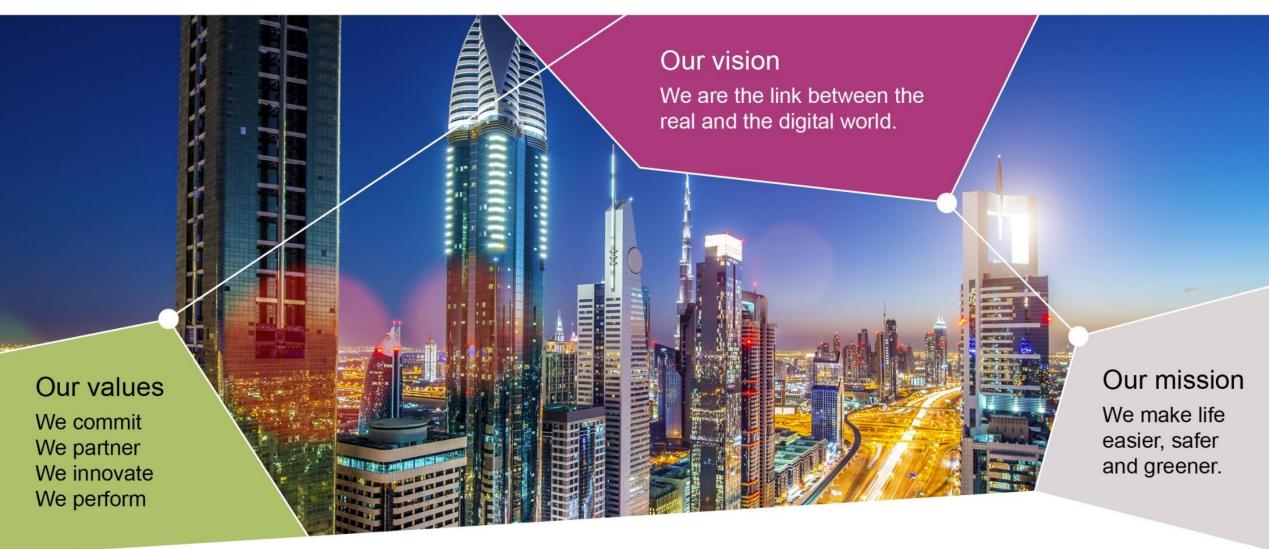
3Omdia,
March 2021

For further information: <u>Infineon Annual Report 2020</u>

^{**}as of 1 April 2021

A world leader in semiconductor solutions





Part of your life. Part of tomorrow.

Global megatrends underline the increasing importance of microelectronics





Demographic & social change

Climate change & resource scarcity







Business growth in the semiconductor market is driven by four areas



Energy efficiency





Growth area: Energy efficiency

Rising demand for energy, growing depletion of fossil resources and climate change challenge our world to find smarter, more efficient ways of generating, transmitting, distributing, storing and using energy. The efficiency potential of technology and semiconductors in particular can throughout the entire energy conversion chain significantly contribute to achieving the long-term, global savings goals.

A strong commitment to energy efficiency has been part of Infineon's DNA for over 40 years. As the global leader in power semiconductors, our products and solutions allow energy to be generated more efficiently – especially from renewable sources, to be transmitted and distributed with reduced losses and to be used across the widest application spectrum from electric vehicles through data centers to smart buildings.

Growth drivers and major product categories

- Power generation from renewable energy sources: IGBT modules, SiC modules, discrete power devices
- Energy transmission and distribution: High-power IGBT modules
- Energy storage: IGBT modules, SiC modules
- Energy usage: Discrete power devices, IGBT modules, driver ICs, MCUs, SiC modules, SiC MOSFETs, SiC diodes, GaN HEMTs

Mobility





Megatrends like demographic shifts, social change and urbanization present society with new mobility challenges. Cities need to manage growing public and private traffic volumes while also mitigating the environmental and climate impact of all this mobility.

Through its semiconductors, Infineon is building more intelligence, responsiveness and autonomy into transport systems – enabling mobility solutions ranging from eBikes and eScooters through hybrid and fully electric vehicles to underground and high-speed trains.

Growth drivers and major product categories

- Electro-mobility: IGBT modules, SiC modules, discrete power devices, MCUs, sensors
- Charging infrastructure for electro mobility: IGBT modules, SiC modules, SiC discretes, discrete power devices, MCUs, security solutions
- Automated driving: Sensors, radar, MCUs, power devices, memories, connectivity and security solutions
- Passenger and freight transport: High-power IGBT modules
- Infotainment: MCUs, touch control, Wi-Fi/BT controllers, USB Type-C PD controllers

Security



Growth area: Security

In an increasingly digital world with more and more connected devices, people want to interact and communicate in a secure way that protects their data against theft and misuse. Securing electronic devices and infrastructures is a number one priority.

Addressing this need for security is one of Infineon's key competencies. We provide our customers with robust, future-oriented embedded security hardware for electronic devices, computer systems, network components and industrial facilities.

Growth drivers and major product categories

- Mobile devices: Security solutions based on contactless and dual-interface security controllers
- Authentication for the IoT: Embedded security solutions
- Industrial application: Embedded security solutions, TPMs, connectivity solutions
- Connected vehicles: Embedded SIMs, connectivity solutions
- > Integrity of devices: TPMs

IoT and big data





The IoT is reaching a breakthrough point as technologies and components work together more seamlessly. Smart and connected objects link the real with the digital world, helping us to tackle the major challenges of our time, such as climate change and the growing world population.

It is impossible to imagine the world of IoT and big data without microchips, which is why Infineon is the backbone of the IoT. Our capabilities in sensing, computing, actuating, connecting and securing unlock new markets and applications. They make the IoT smart, easy and energy-efficient. As a leader in semiconductor system solutions, we make the IoT what it needs to be: secure, easy and real. We make the IoT work.

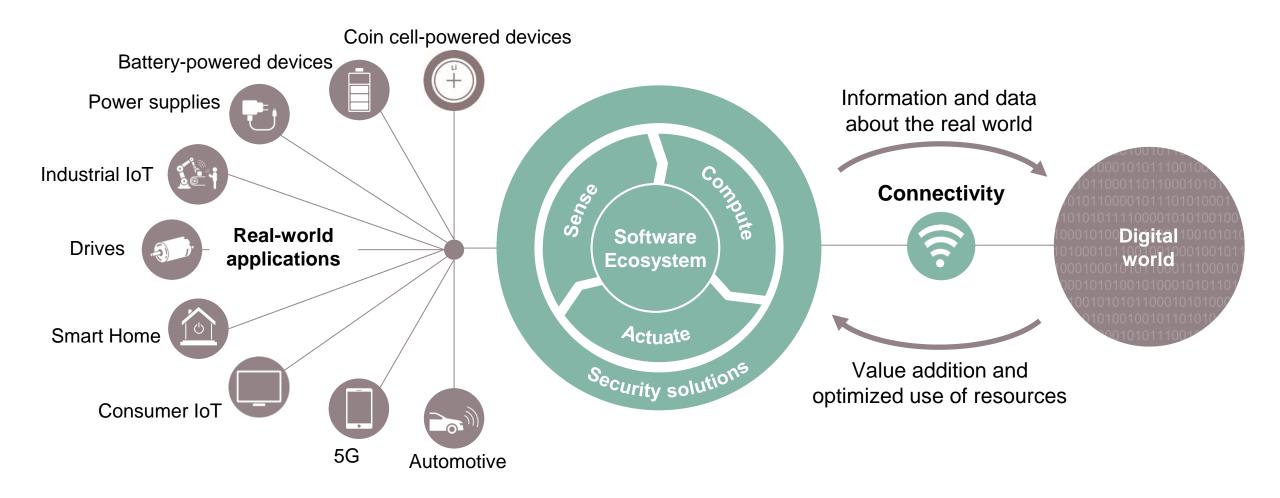
Growth drivers and major product categories

- Smart cars: Sensors, radar, MCUs, power devices, memories, connectivity solutions, security solutions
- Smart home and smart building: Sensors, MCUs, power devices, memories, connectivity solutions, security solutions
- Smart things: Sensors, MCUs, power devices, memories, connectivity solutions, security solutions
- Smart factory: Sensors, MCUs, power devices, memories, connectivity solutions, security solutions
- Data and communication infrastructure: Power devices, memories, SiC devices, GaN HEMTs, RF devices

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Infineon offers a unique portfolio that links the real and the digital world





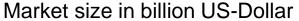
Sense: sensors Compute: microcontrollers, memories Actuate: power semiconductors Connectivity: Wi-Fi, Bluetooth, USB

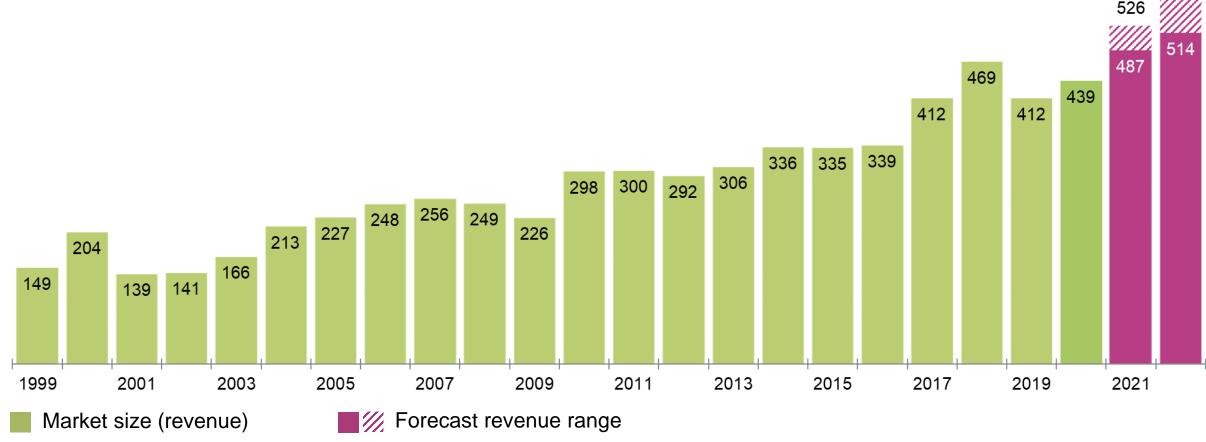
Semiconductor market will grow strongly in 2021 and 2022 according to forecasts



581







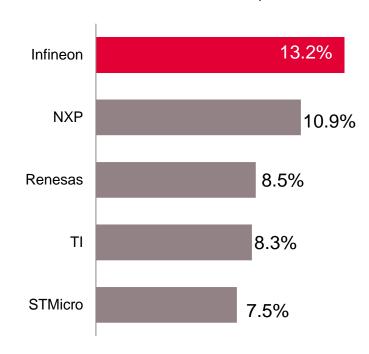
Source: WSTS for historical data. Forecast: Ø of WSTS, Omdia, Gartner, IC Insights, VLSI Research; last update 26 April 2021





Automotive semiconductors

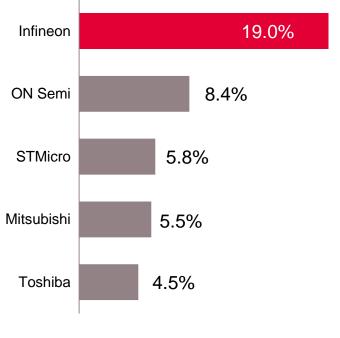
total market in 2020: \$35.0bn



Source: Based on or includes research from Strategy
Analytics, "Automotive Semiconductor Vendor
Market Shares", April 2021

Power discretes and modules

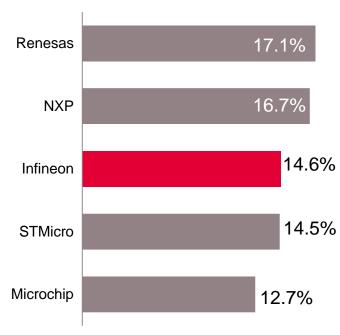
total market in 2019: \$21.0bn



Source: Based on or includes research from Omdia, "Power Semiconductor Market Share Database – 2020", September 2020

Microcontroller suppliers

total market in 2020: \$17.3bn



Source: Based on or includes research from Omdia,

"Annual 2001-2020 Semiconductor

Market Share Competitive Landscaping Tool –

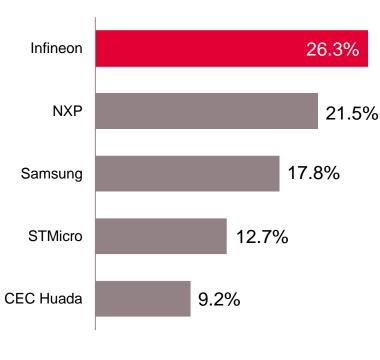
Q4 2020", March 2021

Infineon is a top player in all target markets



Security ICs

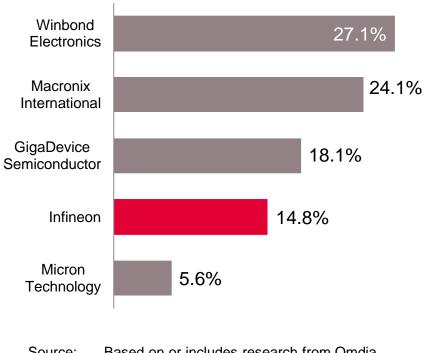
total market in 2019: \$2.8bn



Source: Based on or includes research from ABI Research, "Smart Card and Embedded Security", October 2020

NOR Flash

total market in 2020: \$2.4bn



Source: Based on or includes research from Omdia,

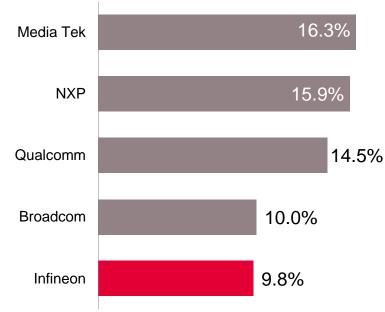
"Annual 2001-2020 Semiconductor

Market Share Competitive Landscaping Tool -

Q4 2020", March 2021

Wi-Fi standalone ICs

total market in 2019: 987m units



Infineon is focusing on wearables and IoT but not addressing routers, PCs, notebooks, tablets.

Source: Based on or includes research from ABI

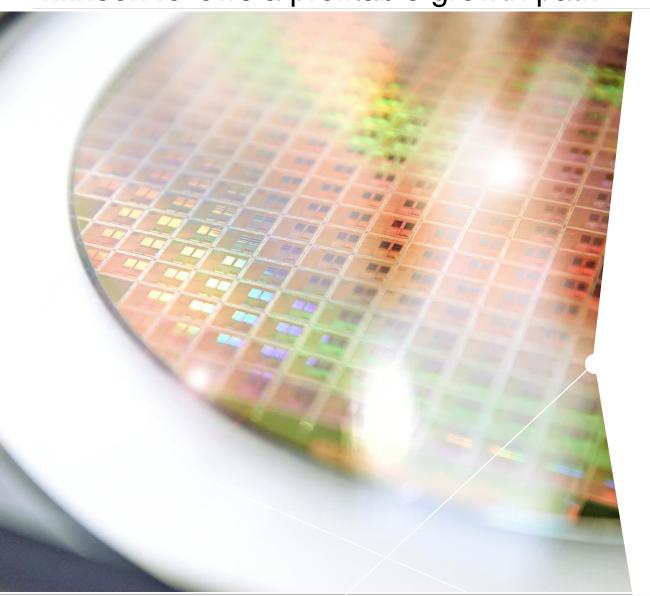
Research, "Wireless Connectivity Technology

Segmentation and Addressable Markets – Q3

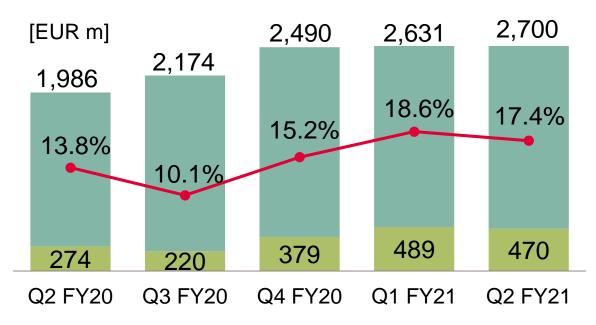
2020 Update", July 2020

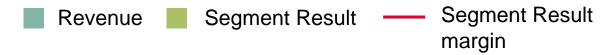






Revenue and Result





Revenue Split by Segment



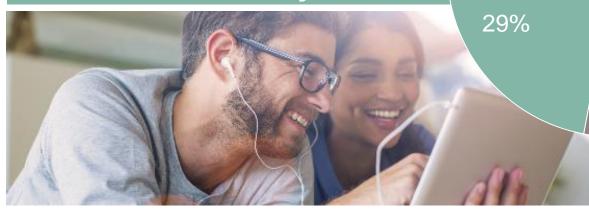
Connected Secure Systems



Automotive



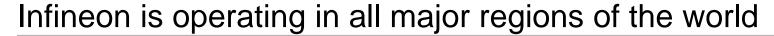
Power & Sensor Systems



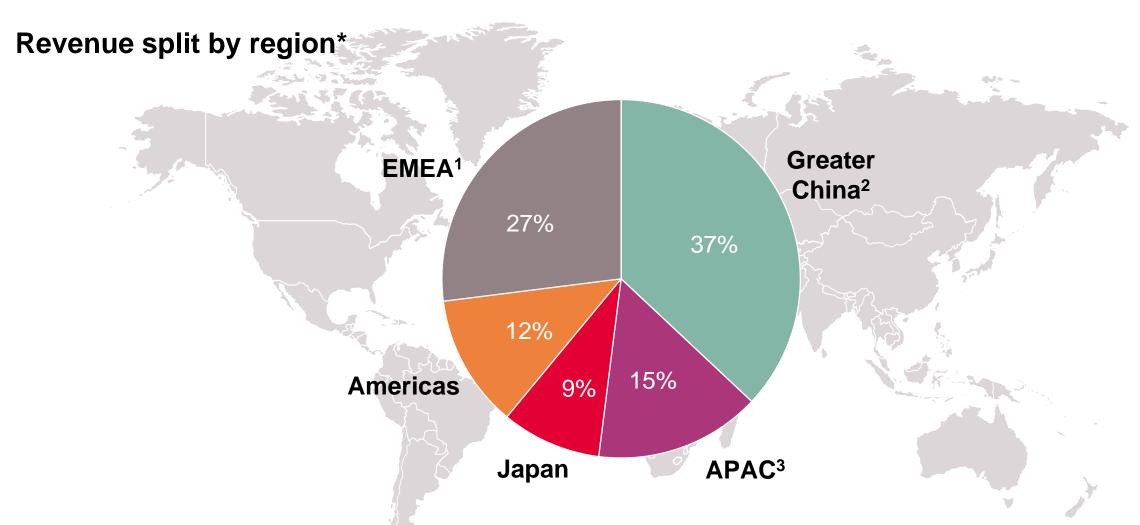
Industrial Power Control



*2020 Fiscal Year (as of 30 September 2020)







¹ Europe, Middle East, Africa ² Greater China comprises Mainland China, Hong Kong and Taiwan ³ Asia Pacific (excluding Greater China and Japan)

^{* 2020} Fiscal Year (as of 30 September 2020)

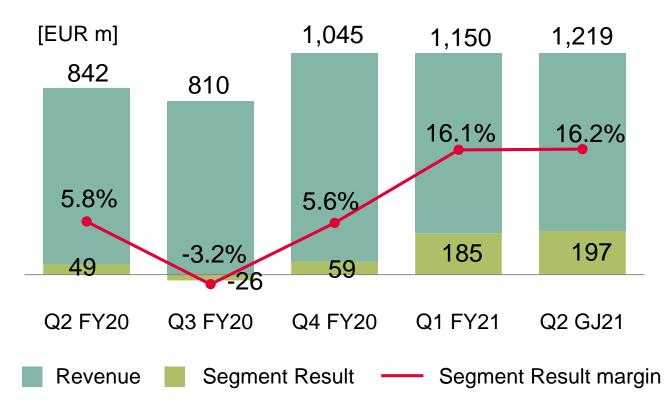
Automotive shapes the future of mobility with microelectronics enabling clean, safe and smart cars





Core applications:

Assistance systems and safety systems, Comfort electronics, Infotainment, Powertrain, Security



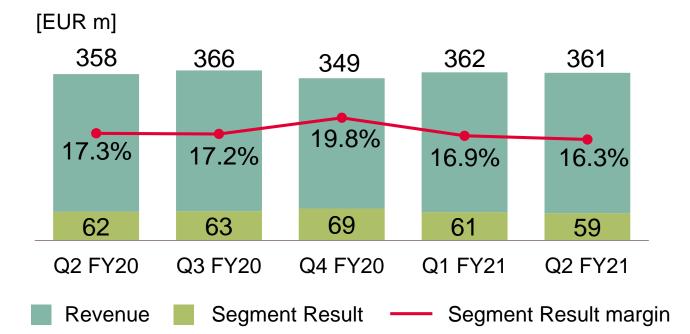


Industrial Power Control empowers a world of unlimited energy



Core applications:

Energy generation, Energy storage, Energy transmission, Home appliances, Industrial drives, Industrial power supplies, Industrial Robotics, Industrial vehicles, Traction



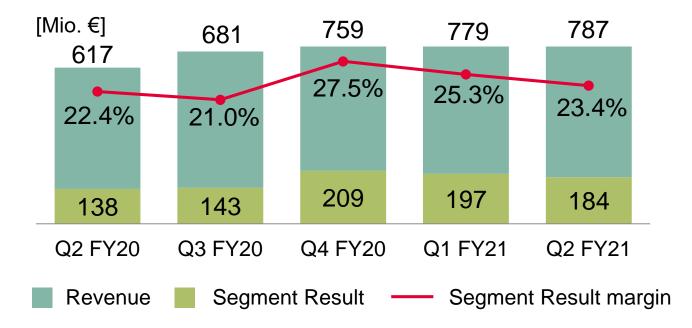
Power & Sensor Systems drives leading-edge power management, sensing and data transfer capabilities





Core applications:

Audio amplifiers, BLDC motor, Cellular communications infrastructure, Charging stations for electric vehicles, HiRel, Human-Machine-Interaction, Internet of Things, LED and conventional lighting systems, Mobile devices, Power management



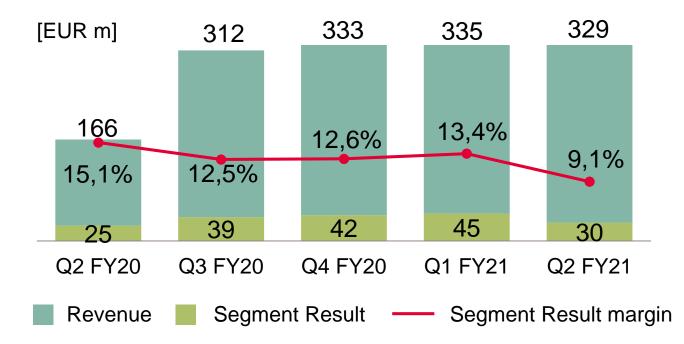
Connected Secure Systems delivers full systems for a connected, secure world





Core applications:

Authentication, Automotive, Consumer electronics, Government identification documents, Internet of Things, Mobile communications, Payment systems, Ticketing, Access control, Trusted computing



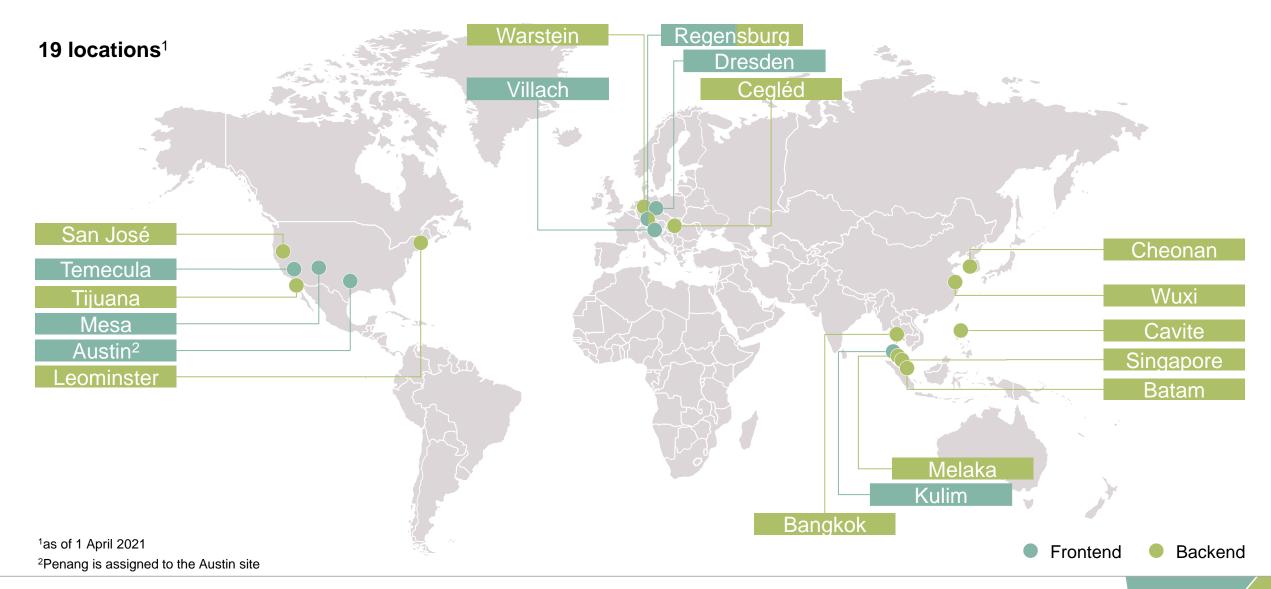
Close customer relationships are based on system know-how and application understanding





Infineon is globally positioned with its network of front-end and back-end manufacturing facilities





Our global Research and Development activities



24

About 13 percent

of Infineon's annual revenue goes into Research and Development (R&D). In fiscal year 2020, R&D investments amounted to 1.1 billion euros.



show a high level of innovative strength and long-term competitiveness. In fiscal year 2020 alone, Infineon registered 1,690 new patents.

Numerous innovative ecosystems

with tech companies, universities and research institutes are of great importance to Infineon.



60* sites in 20 countries and regions:

| Americas | Richmond (Canada); Tijuana (Mexico); Andover, Austin, Chandler, Colorado Springs, El Segundo, Hazlet, Irvine, Lexington, Lynnwood, Milpitas, Portland, San Diego, San José, Temecula and Warwick (all USA) | | |
|---------------|---|--|--|
| APAC | Bangalore (India); Seoul (Korea); Ipoh, Kulim, Melaka and Penang (all Malaysia); Batam Island (Indonesia), Muntinlupa (Philippines); Singapore | | |
| Greater China | Chengdu, Shanghai, Shenzen, Xi'an (all Mainland China); Hsinchu and Taipei (both Taiwan) | | |
| Japan | Kawasaki, Musashi Kosugi, Nagoya, Sendai (all Japan) | | |
| Europe | Herlev (Denmark); Augsburg, Dresden, Duisburg, Erlangen, Langen, Martinsried, Neubiberg, Regensburg and Warstein (all Germany); Le Puy-Sainte-Réparade (France); Bristol and Reigate (both Great Britain); Cork and Dublin (both Ireland); Netanya (Israel); Padua and Pavia (both Italy); Graz, Linz and Villach (all Austria); Cegléd (Hungary), Bukarest (Rumania); Lviv (Ukraine) | | |

as of 30 September 2020 *as of 1 April 2021







Infineon ranks among the 10 percent¹ most sustainable companies in the world

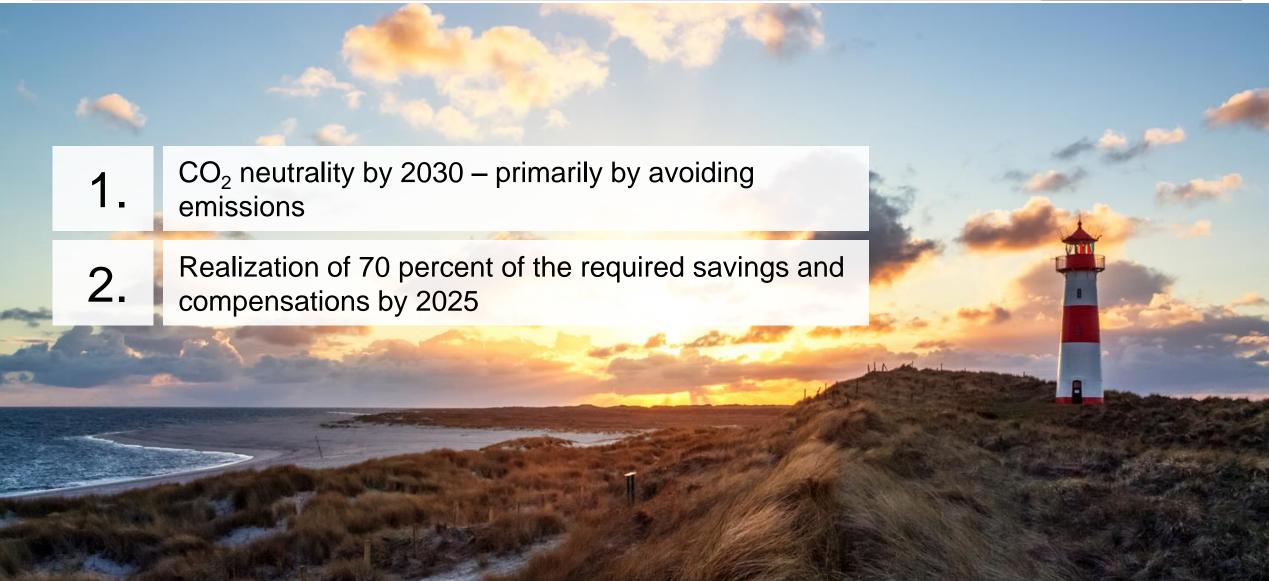
- Sustainability at Infineon includes social, ecological and economic values
- Infineon was one of the first semiconductor companies to voluntarily commit to the Ten Principles of the UN Global Compact
- Infineon meets global societal challenges such as climate protection, energy efficiency and resource management with innovative products
- Infineon's climate target is to become carbon-neutral by 2030². Emissions are to be cut by 70 percent over the 2019 calendar year³ levels by 2025
- External evaluation of the commitment:
 - MSCI ESG Research rates Infineon with AA for the second consecutive year
 - Included in the Dow Jones Sustainability™ World Index for the sixth time
 - Received "Gold Status" of the rating agency EcoVadis for the sixth time

For further information: <u>Infineon Sustainability Report 2020</u>

¹ Based on the results of The Sustainability Yearbook 2020 by S&P Global in cooperation with RobecoSam 2 in terms of Infineon's direct and indirect energy- and heat-related emissions (Scope 1 and 2) 3 including Cypress



Infineon is committed to binding CO₂ reduction targets



Corporate Social Responsibility We create a net ecological benefit



Our products and solutions enable a net ecological benefit, equal to the average annual CO₂ emissions from electricity consumption of more than 90 million people living in Europe¹

CO₂ burden²
of around
1.61 million tons
CO₂ equivalents



CO₂ savings³
of around
56 million tons
CO₂ equivalents

Net ecological benefit: CO₂ emissions reduction of more than 54 million tons









market share, semiconductor share and the lifetime of the technologies concerned, based on internal and external experts' estimations. Despite the fact that carbon footprint calculations are subject to imprecision due to the complex issues involved, the results are nevertheless clear.

¹ Based on the average electricity consumption of private households in Germany and official energy conversion factors.

² This figure takes into account manufacturing, transportation, own vehicles, flights, raw materials and consumables, chemicals, water/waste water, direct emissions, energy consumption, waste etc. at all production sites included in IMPRES and at the Campeon headquarters (Germany), as well as direct and indirect energy-related emissions by manufacturing service providers. It is based on data collected internally and publicly available conversion factors and relates to the 2020 fiscal year.

³ This figure is based on internally established criteria, which are described in the explanatory notes. The figure relates to the 2019 calendar year and takes into account the following application areas: automotive, LED, induction cookers, servers, renewable energy (wind, photovoltaic) and cell phone chargers as well as drives. CO2 savings are calculated based on the potential savings generated by technologies in which semiconductors are used. The CO2 savings are allocated based on Infineon's

Infineon's employees create a better future together





Preethi Baran Director, Field Sales, in Livonia

"It's motivating to work with our customers to transform our mobility through innovation, safety and security."



Thomas Wrzesinsky Maintenance Technician, in Dresden

"We maintenance technicians keep production moving. I appreciate the teamwork: when everyone pulls together to find the error and to get the equipment running again."



Marcel Kuba
Director, Field Application
Engineering, in Munich

"The acquisition of Cypress enables Infineon now to offer complete best in class system solutions for new automotive applications."



Dr. Pamela LinSenior Engineer Advanced
Analytics, in Singapore

"It's amazing how we use advance data analytics & AI techniques to create intelligent systems for solving complex business problems and driving manufacturing efficiency."

At Infineon, **46,700*** people from over **100** countries work together around the world toward one mission: to make life **easier**, **safer** and **greener**.

For more information please visit www.infineon.com/career



Our competitive advantage: Differentiating as quality leader



Business Continuity Integrated management



| Real Estate and Facility Management | Loss & Fraud Investigations | Environmental Protection, Sustainability and Climate Protection | Business & Operations Support |
|---|--|---|--------------------------------------|
| Asset Protection | | nuity SO 45001* SO 50001*** | Security and Crisis Management |
| Corporate Social Responsibility | Information/ IT Security and Data Protection | Business Continuity Planning | Export Compliance |

^{*}ISO 27001/14001/45001 worldwide certification scheme; **ISO 22301 certified in Villach and Dresden; ***ISO 50001 certified at EU sites



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